

	Hits	Search Text	DBs
21	77	((substrate or wafer) same (panel\$3 or unit or clich\$2 or area or region or divid\$3) same (groove or etch\$2 or recess\$3 or raise\$2) same pattern\$4) and ((transfer\$3 or roll\$3 or collector or print\$4) same (blanket or film or layer or adhesion or adhesive) same (print\$3 near9 roll\$3) same (resist or photoresist or (cur\$4 near12 material)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
22	1214	(printing adj (roll or cylinder)).ti,ab.	US-PGPUB; USPAT
23	108	S24 and S26	US-PGPUB; USPAT
24	413	S24 and (printing adj (roll or cylinder))	US-PGPUB; USPAT
25	1940	blanket.ti.ab.	US-PGPUB; USPAT
26	5540	blanket.ti,ab.	US-PGPUB; USPAT
27	68	((printing adj (roll or cylinder)) near12 blanket) same (pattern or resist or photoresist))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
28	14	((printing adj (roll or cylinder)) near22 blanket) same (pattern or resist or photoresist) same adhesi\$4)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB